

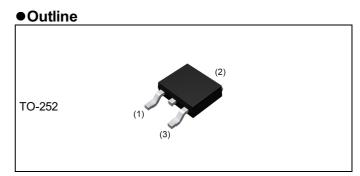
V _{DSS}	60V
R _{DS(on)} (Max.)	40mΩ
Ι _D	±15A
P _D	20W

Features

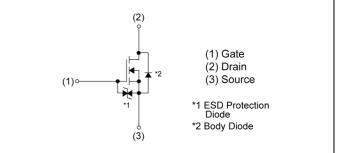
Application

Switching

- 1) Low on resistance.
- 2) Fast switching speed.
- 3) Drive circuits can be simple.
- 4) Parallel use is easy.
- 5) Pb-free lead plating ; RoHS compliant



●Inner circuit



Packaging specifications

	Packing	Embossed Tape
	Reel size (mm)	330
_	Tape width (mm)	16
Туре	Basic ordering unit (pcs)	2500
	Toping and	TL
	Taping code	TL1
	Marking	RD3L150SN

• Absolute maximum ratings (T_a = 25°C ,unless otherwise specified)

Parameter	Symbol	Value	Unit
Drain - Source voltage	V _{DSS}	60	V
Continuous drain current	I _D *1	±15	А
Pulsed drain current	I _{DP} *2	±30	А
Gate - Source voltage	V _{GSS}	±20	V
Power dissipation	P _D *3	20	W
Junction temperature	Tj	150	°C
Operating junction and storage temperature range	T _{stg}	-55 to +150	°C

1/12

•Thermal resistance

Parameter	Symbol	Values			Linit
Farameter	Symbol	Min.	Тур.	Max.	Unit
Thermal resistance, junction - case	R_{thJC}^{*3}	-	-	6.25	°C/W

•Electrical characteristics (T_a = 25°C)

Deverseter	Currente e l	Canditiana	Values			1.1:4	
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit	
Drain - Source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D = 1mA	60	-	-	V	
Breakdown voltage temperature coefficient	$\frac{\Delta V_{(BR)DSS}}{\Delta T_j}$	I _D = 1mA referenced to 25°C	-	63.7	-	mV/°C	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 60V, V _{GS} = 0V	-	-	1	μA	
Gate - Source leakage current	I _{GSS}	V_{GS} = ±20V, V_{DS} = 0V	-	-	±10	μA	
Gate threshold voltage	$V_{GS(th)}$	V _{DS} = 10V , I _D = 1mA	1.0	I	3.0	V	
Gate threshold voltage temperature coefficient	$\frac{\Delta V_{GS(th)}}{\Delta T_j}$	I _D = 1mA referenced to 25°C	-	-4.4	-	mV/°C	
		V _{GS} = 10V, I _D = 15A	-	28	40		
Static drain - source on - state resistance	R _{DS(on)} *4	V _{GS} = 4.5V, I _D = 15A	-	33	47	mΩ	
		V _{GS} = 4.0V, I _D = 15A	-	36	51		
Gate resistance	R _G	f = 1MHz, open drain	-	4.2	-	Ω	
Forward Transfer Admittance	Y _{fs} ^{*4}	V _{DS} = 10V, I _D = 15A	7	-	-	S	

*1 Limited only by maximum temperature allowed.

*2 Pw \leq 10µs , Duty cycle \leq 1%

*3 T_C=25°C

*4 Pulsed



• Electrical characteristics ($T_a = 25^{\circ}C$)

Deremeter	Sumpleal	Conditions	Values			Unit	
Parameter	Symbol Conditions -		Min.	Тур.	Max.	UTIIL	
Input capacitance	C _{iss}	V _{GS} = 0V	-	930	-		
Output capacitance	C _{oss}	V _{DS} = 10V	-	200	-	pF	
Reverse transfer capacitance	C _{rss}	f = 1MHz	-	80	-		
Turn - on delay time	t _{d(on)} *4	$V_{DD} \simeq 30V, V_{GS}$ = 10V	-	10	-		
Rise time	t _r *4	I _D = 7.5A	-	30	-	20	
Turn - off delay time	$t_{d(off)}^{*4}$	$R_L \simeq 4.0\Omega$	-	45	-	ns	
Fall time	t_{f}^{*4}	R _G = 10Ω	-	15	-		

• Gate charge characteristics ($T_a = 25^{\circ}C$)

Deremeter	Sumbol	Conditions	Values			Unit
Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Total gate charge	Q_g^{*4}	V _{DD} ≃ 30V,	-	18.0	-	
Gate - Source charge	Q _{gs} *4	I _D = 15A,	-	3.2	-	nC
Gate - Drain charge	Q _{gd} *4	V _{GS} = 10V	-	3.8	-	

•Body diode electrical characteristics (Source-Drain) (T_a = 25°C)

Parameter	Symbol	Conditions	Values			Unit
Farameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Continuous forward current	۱ _s *1	T - 25°0	-	-	15	А
Pulse forward current	I_{SP}^{*2}	T _a = 25°C	-	-	30	А
Forward voltage	V_{SD}^{*4}	V _{GS} = 0V, I _S = 15A	-	-	1.2	V



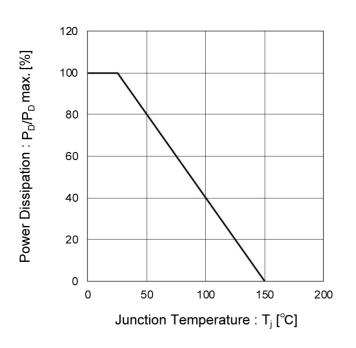


Fig.1 Power Dissipation Derating Curve

Fig.2 Maximum Safe Operating Area

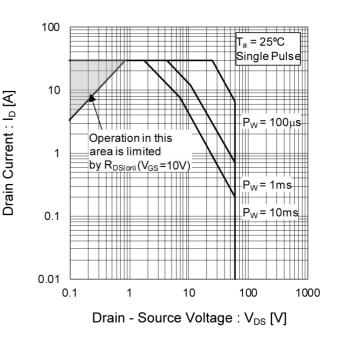
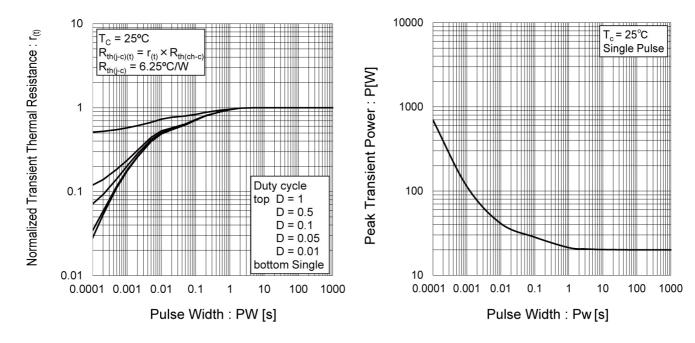


Fig.3 Normalized Transient Thermal Resistance vs. Pulse Width

Fig.4 Single Pulse Maximum Power dissipation



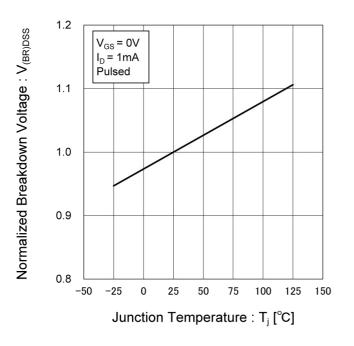


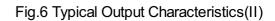
Drain Current : I_D [A]

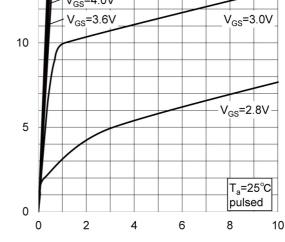
15 15 V_{GS}=10.0V T_a=25°C V_{GS}=10.0V V_{GS}=4.5V pulsed V_{GS}=4.5V V_{GS}=4.0V V_{GS}=4.0V V_{GS}=3.6V V_{GS}=3.0V V_{GS}=3.6V Drain Current : I_D [A] 10 10 V_{GS}=3.0V V_{GS}=2.8V 5 5 V_{GS}=2.8V T_a=25°C pulsed 0 0 0.2 0.4 0.6 0.8 1.0 0 2 4 6 8 0 Drain - Source Voltage : V_{DS} [V] Drain - Source Voltage : V_{DS} [V]

Fig.5 Typical Output Characteristics(I)

Fig.7 Breakdown Voltage vs. **Junction Temperature**









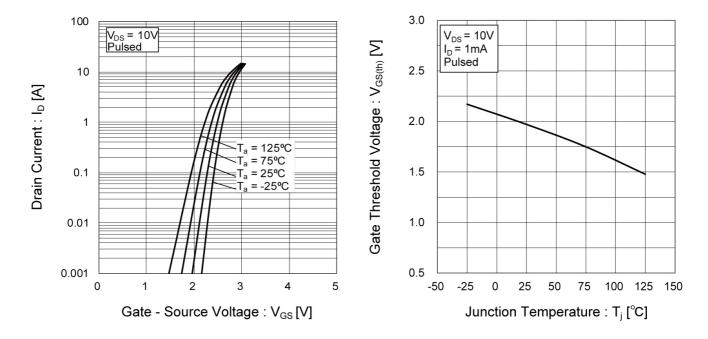
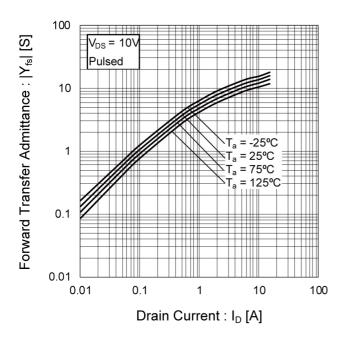


Fig.8 Typical Transfer Characteristics

Fig.9 Gate Threshold Voltage vs. Junction Temperature

Fig.10 Forward Transfer Admittance vs. Drain Current





• Electrical characteristic curves

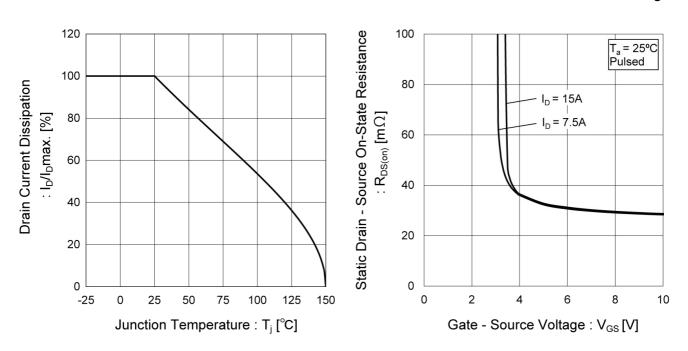
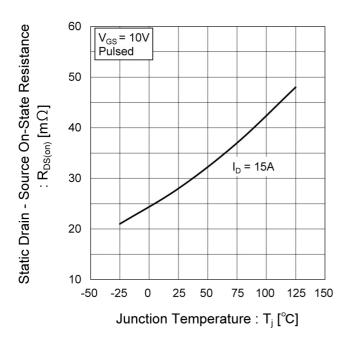


Fig.11 Drain Current Derating Curve

Fig.12 Static Drain - Source On - State Resistance vs. Gate Source Voltage

Fig.13 Static Drain - Source On - State Resistance vs. Junction Temperature





Electrical characteristic curves

Fig.14 Static Drain - Source On - State

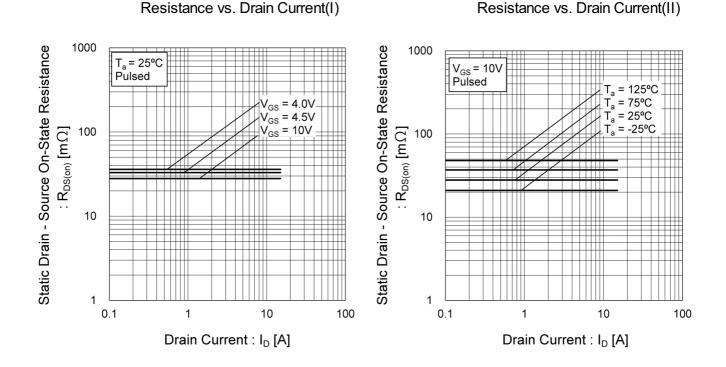
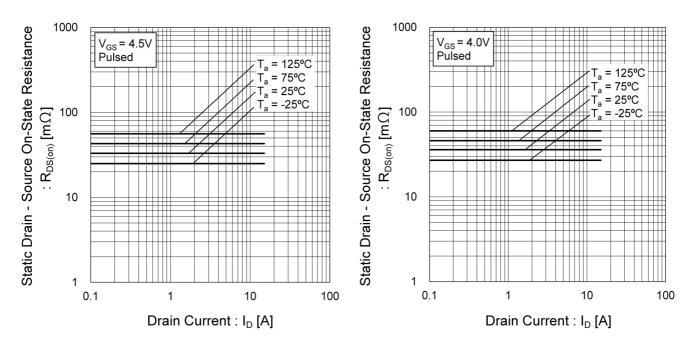


Fig.16 Static Drain - Source On - State Resistance vs. Drain Current(III) Fig.17 Static Drain - Source On - State Resistance vs. Drain Current(IV)

Fig.15 Static Drain - Source On - State





• Electrical characteristic curves

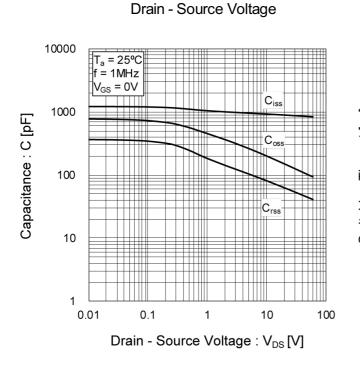


Fig.18 Typical Capacitance vs.

Fig.19 Switching Characteristics

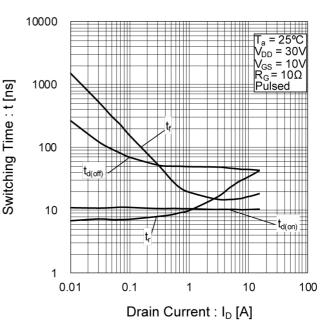


Fig.20 Dynamic Input Characteristics

Gate - Source Voltage : V_{GS} [V]

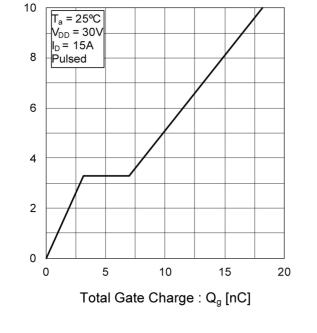
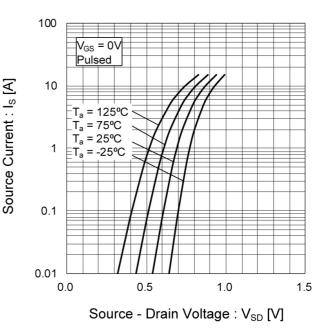


Fig.21 Source Current vs. Source Drain Voltage





• Measurement circuits

Fig.1-1 Switching Time Measurement Circuit

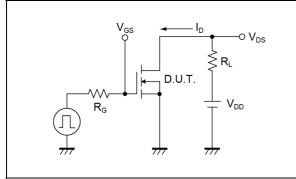


Fig.2-1 Gate Charge Measurement Circuit

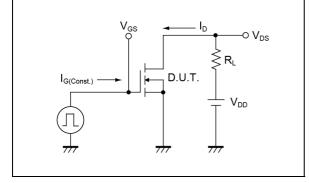
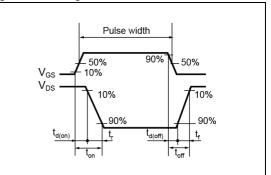
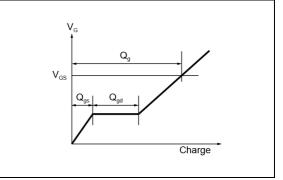


Fig.1-2 Switching Waveforms

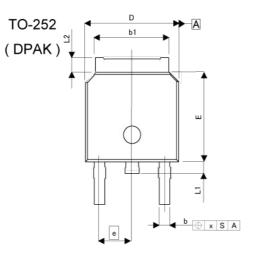


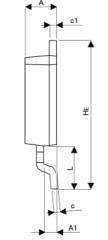


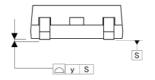


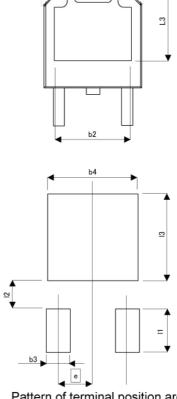


$\bullet \textit{Dimensions}(\mathsf{TL})$









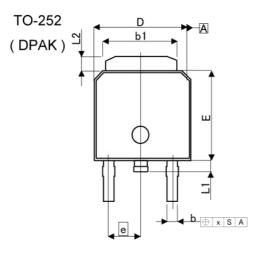
Pattern of terminal position areas [Not a pattern of soldering pads]

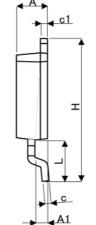
DIM	MILIME	ETERS	INCI	HES	
DIM	MIN	MAX	MIN	MAX	
A	2.10	2.30	0.083	0.091	
A1	0.70	1.10	0.028	0.043	
b	0.65	0.85	0.026	0.033	
b1	5.10	5.40	0.201	0.213	
b2	5.	10	0.2	201	
С	0.40	0.60	0.016	0.024	
c1	0.40	0.60	0.016	0.024	
D	6.40	6.80	0.252	0.268	
е	2.	30	0.0	91	
E	6.00	6.40	0.236	0.252	
HE	9.50	10.50	0.374	0.413	
L	2.	90	0.1	14	
L1	0.70	0.90	0.028	0.035	
L2	0.70	1.30	0.028	0.051	
L3	5.	30	0.209		
х	-	0.10	-	0.004	
у	-	0.10	-	0.004	
	hall in ar	TEDO	INC	150	
DIM		TERS	INCHES		
F 0	MIN	MAX	MIN	MAX	
b3	-	1.10	-	0.043	
b4	-	5.40	-	0.213	
1		90	0.0		
12		00	0.079		
13	5.30		0.2	:09	

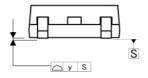
Dimension in mm/inches

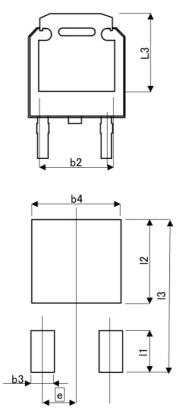


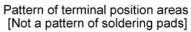
• Dimensions (TL1)











DIM	MILIMETERS		INCI	HES
DIM	MIN	MAX	MIN	MAX
A	2.20	2.40	0.087	0.094
A1	0.70	1.10	0.028	0.043
b	0.60	0.90	0.024	0.035
b1	5.20	5.50	0.205	0.217
b2	5.	35	0.2	211
С	0.40	0.60	0.016	0.024
c1	0.40	0.60	0.016	0.024
D	6.40	6.80	0.252	0.268
е	2.	30	0.0)91
E	6.00	6.40	0.236	0.252
HE	9.40	10.40	0.370	0.409
L	2.	70	0.1	06
L1	0.60	1.00	0.024	0.039
L2	0.70	1.30	0.028	0.051
L3	5.30		0.2	209
x	1-11	0.25	-	0.010
у	127	0.10	2	0.004
DIM	MILIME	MILIMETERS		HES
	MIN	MAX	MIN	MAX
b3	-	1.15	-	0.045
b4		5.55	-	0.219
1	()	2.77	-	0.109
12	-	5.50	-	0.217
13	-	10.40	-	0.409

Dimension in mm/inches





Notice

Precaution on using ROHM Products

1. Our Products are designed and manufactured for application in ordinary electronic equipments (such as AV equipment, OA equipment, telecommunication equipment, home electronic appliances, amusement equipment, etc.). If you intend to use our Products in devices requiring extremely high reliability (such as medical equipment ^(Note 1), transport equipment, traffic equipment, aircraft/spacecraft, nuclear power controllers, fuel controllers, car equipment including car accessories, safety devices, etc.) and whose malfunction or failure may cause loss of human life, bodily injury or serious damage to property ("Specific Applications"), please consult with the ROHM sales representative in advance. Unless otherwise agreed in writing by ROHM in advance, ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of any ROHM's Products for Specific Applications.

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JÁPAN	USA	EU	CHINA
CLASSⅢ	CLASSⅢ	CLASS II b	CLASSII
CLASSⅣ	CLASSII	CLASSⅢ	CLASSI

- 2. ROHM designs and manufactures its Products subject to strict quality control system. However, semiconductor products can fail or malfunction at a certain rate. Please be sure to implement, at your own responsibilities, adequate safety measures including but not limited to fail-safe design against the physical injury, damage to any property, which a failure or malfunction of our Products may cause. The following are examples of safety measures:
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 - [b] Use of our Products outdoors or in places where the Products are exposed to direct sunlight or dust
 - [c] Use of our Products in places where the Products are exposed to sea wind or corrosive gases, including Cl₂, H₂S, NH₃, SO₂, and NO₂
 - [d] Use of our Products in places where the Products are exposed to static electricity or electromagnetic waves
 - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
 - [f] Sealing or coating our Products with resin or other coating materials
 - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
 - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
- 7. De-rate Power Dissipation depending on ambient temperature. When used in sealed area, confirm that it is the use in the range that does not exceed the maximum junction temperature.
- 8. Confirm that operation temperature is within the specified range described in the product specification.
- 9. ROHM shall not be in any way responsible or liable for failure induced under deviant condition from what is defined in this document.

Precaution for Mounting / Circuit board design

- 1. When a highly active halogenous (chlorine, bromine, etc.) flux is used, the residue of flux may negatively affect product performance and reliability.
- 2. In principle, the reflow soldering method must be used on a surface-mount products, the flow soldering method must be used on a through hole mount products. If the flow soldering method is preferred on a surface-mount products, please consult with the ROHM representative in advance.

For details, please refer to ROHM Mounting specification

Precautions Regarding Application Examples and External Circuits

- 1. If change is made to the constant of an external circuit, please allow a sufficient margin considering variations of the characteristics of the Products and external components, including transient characteristics, as well as static characteristics.
- 2. You agree that application notes, reference designs, and associated data and information contained in this document are presented only as guidance for Products use. Therefore, in case you use such information, you are solely responsible for it and you must exercise your own independent verification and judgment in the use of such information contained in this document. ROHM shall not be in any way responsible or liable for any damages, expenses or losses incurred by you or third parties arising from the use of such information.

Precaution for Electrostatic

This Product is electrostatic sensitive product, which may be damaged due to electrostatic discharge. Please take proper caution in your manufacturing process and storage so that voltage exceeding the Products maximum rating will not be applied to Products. Please take special care under dry condition (e.g. Grounding of human body / equipment / solder iron, isolation from charged objects, setting of lonizer, friction prevention and temperature / humidity control).

Precaution for Storage / Transportation

- 1. Product performance and soldered connections may deteriorate if the Products are stored in the places where:
 - [a] the Products are exposed to sea winds or corrosive gases, including Cl2, H2S, NH3, SO2, and NO2
 - [b] the temperature or humidity exceeds those recommended by ROHM
 - [c] the Products are exposed to direct sunshine or condensation
 - [d] the Products are exposed to high Electrostatic
- 2. Even under ROHM recommended storage condition, solderability of products out of recommended storage time period may be degraded. It is strongly recommended to confirm solderability before using Products of which storage time is exceeding the recommended storage time period.
- 3. Store / transport cartons in the correct direction, which is indicated on a carton with a symbol. Otherwise bent leads may occur due to excessive stress applied when dropping of a carton.
- 4. Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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RD3L150SN - Web Page

Part Number	RD3L150SN
Package	TO-252
Unit Quantity	2500
Minimum Package Quantity	2500
Packing Type	Taping
Constitution Materials List	inquiry
RoHS	Yes